Date Notice Posted	May 16, 2017
	(OPRPM use only)

UNIVERSITY OF HAWAI'I NOTICE OF AWARD

Solicita	ation No:	IFB No. 17-033	0					
Title:	Furnish and Deliver LPKF Photolaser S Printed Circuit Board Prototyping Machine, Electronic and							
	Computer I	Engineering Tecl	hnology Departm	ent, University of Ha	awaii - Maui	College, Kah	alui, Hawaii	
Descri	iption and	quantity of ite	m(s):					
Quantity Des		Description	<u>on</u>					
		BASIC BID						
Party to be awarded:			LPKF Distribu	tion, Inc.				
Address:								
City: _			State:	Oregon	Zi	p Code:	97062	
Date Contract to be issued:			May 23, 2017					
Procurement Specialist:			(OPRPM use only) Michele Elmore (OPRPM use only)					

ANY PERSON WISHING TO FILE WRITTEN OBJECTIONS TO THE ISSUANCE OF THE CONTRACT SHALL FILE THEIR OBJECTIONS WITH THE UNIVERSITY OF HAWAI'I, OFFICE OF PROCUREMENT AND REAL PROPERTY MANAGEMENT, 1400 LOWER CAMPUS ROAD, ROOM 15, HONOLULU, HAWAII 96822, WITHIN FIVE (5) WORKING DAYS FROM THE DATE THIS NOTICE WAS POSTED.

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